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**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

Fee et al.

**Serial No.:** 10/728,413

**Filed:** December 5, 2003

**For:** QUAD FLAT NO LEAD (QFN) GRID  
ARRAY PACKAGE, METHOD OF  
MAKING AND MEMORY MODULE AND  
COMPUTER SYSTEM INCLUDING SAME

**Confirmation No.:** 9766

**Examiner:** Unknown

**Group Art Unit:** 2827

**Attorney Docket No.:** 2269-4738.1US  
(00-1113.01/US)

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

May 17, 2004  
Date

*[Signature]*  
Signature

Deidra Dpeil  
Name (Type/Print)

**SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In compliance with the duty to disclose information material to patentability pursuant to 37 C.F.R. § 1.56, it is respectfully requested that this Supplemental Information Disclosure Statement be entered and the documents listed on attached Form PTO-1449 or PTO/SB/08 be considered by the Examiner and made of record. Copies of the listed documents are enclosed pursuant to 37 C.F.R. § 1.98(a). The listed documents were cited by the Office in co-pending application Serial No. 10/729,180, filed on December 5, 2003, and directed to a related invention.

In accordance with 37 C.F.R. § 1.97(g) and (h), filing of this Supplemental Information Disclosure Statement is not to be construed as a representation that a search has been made or an admission that the information cited herein is, or is considered to be, material to patentability as defined in 37 C.F.R. § 1.56(b). Further, no representation is made by Applicants herein that no other possible material information as defined in 37 C.F.R. § 1.56 (b) exists.

<u>U.S. Patent Documents</u>		
<u>U.S. Patent No.</u>	<u>Publication Date</u>	<u>Patentee</u>
US-5,714,800	February 3, 1998	Thompson
US- 6,405,359 B1	June 11, 2002	Tseng et al.
US- 6,350,668 B1	February 26, 2002	Chakravorty
US- 6,284,563 B1	September 4, 2001	Fjelstad

Applicants offer to supply any explanation or discussion of the documents which the Examiner feels is necessary or desirable and which is requested.

This Supplemental Information Disclosure Statement is believed to be filed before the mailing date of a first Office Action on the merits, and therefore no fee is due.

Serial No. 10/728,413

Respectfully submitted,

A handwritten signature in black ink, appearing to read "Bradley B. Jensen", followed by a long horizontal flourish.

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Date: May 17, 2004  
BBJ/nj:dp

Enclosures: Form PTO-1449 or PTO/SB/08  
Copy of documents cited

Document in ProLaw

